The Thirteenth International Conference on Intelligent Information Hiding and
Multimedia Signal Processing (IIH-MSP 2017)
August 12-15, 2017
Matsue, Shimane, Japan
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## CALL FOR PAPERS

INVITED SESSION: *Emerging Techniques and Its Applications*

This invited session will discuss recent advances in the cryptography, data mining, big data, intelligent engineering, economic data analysis, and option. Contributions containing new insights and findings in this field are welcome. This special session provides an international forum for researchers and specialists from the field of merging techniques and its applications. Although particular attention will be given to the above theme areas, it should be stressed that a broad range of submissions are encouraged.

**Full Paper Due Date:** *January 31, 2017*
**Notification:** *February 20, 2017*
**Camera-ready Paper Deadline:** *March 20, 2017*

## SUBMISSION OF PAPERS

Papers are invited from prospective authors with interests in this particular invited session and related areas of application. All contributions should be original and not published elsewhere or intended to be published during the review period. IIH-MSP-2017 conference proceedings will be published in the book series entitled "Smart Innovation, Systems and Technologies", which is on the EI index list, by Springer. Normally, papers published in this book series will be indexed by EI when the paper quality fits the requirement and the publishing procedures (including the oral presentation) are completed. The paper length is 6-8 pages for the regular paper. Each paper is allowed to have maximum 2 extra pages with raising USD 100 registration fee per extra page. All papers must be submitted electronically in PDF format only. Details of the required paper format are available at the official IIH-MSP 2017 website (http://bit.kuas.edu.tw/~iihmsp17). For further information, please contact the session organizers given below.

Special Session Organizers:

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